

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J-MOS series

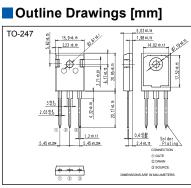
N-Channel enhancement mode power MOSFET

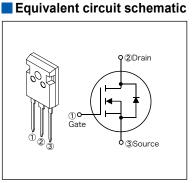
Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

Applications

For switching





Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V _{GS} =-30V
Continuous Drain Current		±40	А	Tc=25°C Note*1
	ID	±25	А	Tc=100°C Note*1
Pulsed Drain Current	IDP	±120	А	Note *1
Gate-Source Voltage	V _{GS}	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	7.6	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	1390	mJ	Note *3
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	kV/μs	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	15	kV/μs	Note *4
Peak Diode Recovery -di/dt	-di/dt	80	A/µs	Note *5
Maximum Dawar Disaination	P	2.5	W	T₂=25°C
Maximum Power Dissipation	FD	315	vv	Tc=25°C
Operating and Starage Temperature range	Tch	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	

Note *1 : Limited by maximum channel temperature. Note *2 : Tch≤150°C, See Fig.1 and Fig.2 Note *3 : Starting Tch=25°C, Ias=4.6A, L=120mH, Vpp=60V, Rg=50Ω, See Fig.1 and Fig.2

EAs limited by maximum channel temperature and avalanche current. Note *4 : Ir≤-ID, -di/dt=80A/µs, VDs peak≤600V, Tch≤150°C.

Note *5 : IF≤-ID, dV/dt=15kV/µs, VDs peak≤600V, Tch≤150°C

Electrical Characteristics at T_c=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	l₀=250μA V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I _D =250µA V _{DS} =V _{GS}		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	-μA
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V _{GS} =±30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	RDS(on)	I _D =20A V _{GS} =10V		-	0.075	0.088	Ω
Gate resistance	RG	f=1MHz, open drain		-	1.1	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	I _D =20A V _{DS} =25V	15	30	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	2735	-	
Output Capacitance	Coss	V _{GS} =0V	-	83	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	6.5	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0480V	-	180	-	pF
Effective output capacitance, time related (Note *7)	C _{o(tr)}	V _{GS} =0V V _{DS} =0480V ID=constant	-	630	-	
Turne On Time	t _{d(on)}		-	99	-	
Turn-On Time	tr	V _{DD} =400V, V _{GS} =10V I _D =20A, R _G =13Ω See Fig.3 and Fig.4	-	24	-	ns
Turn Off Time	t _{d(off)}		-	157	-	
Turn-Off Time tr	tr		-	19	-	
Total Gate Charge	QG		-	100	-	nC
Gate-Source Charge	Q _{GS}	V₀₅=480V, I₀=40A V₀₅=10V See Fig.5	-	24	-	
Gate-Drain Charge	Q _{GD}		-	38	-	
Drain-Source crossover Charge	Qsw		-	14	-	

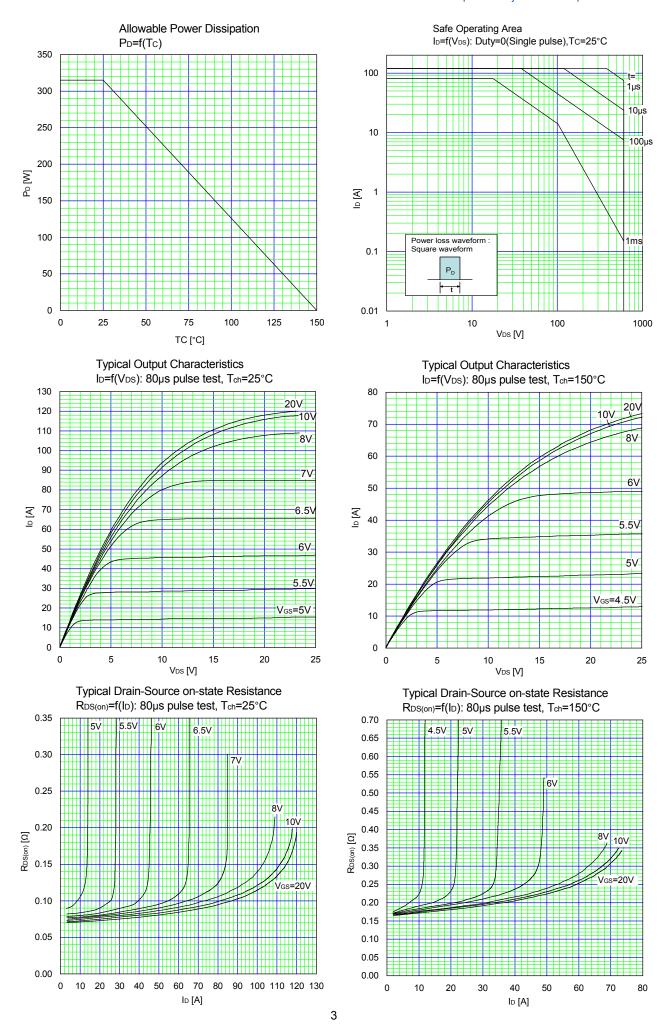
Note *6 : $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{Ds} is rising from 0 to 80% BV_{Dss}. Note *7 : $C_{o(tr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{Ds} is rising from 0 to 80% BV_{Dss}.

Reverse Diode

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=26.7mH, T₀ =25°C See Fig.1 and Fig.2	7.6	-	-	А
Diode Forward On-Voltage	V _{SD}	I⊧=40A, V _{GS} =0V T _{ch} =25°C	-	1	1.35	V
Reverse Recovery Time	trr	- I⊧=40A, V₀₀=400V -di/dt=80A/μs T₅h=25°C See Fig.6 and Fig.7		540	-	ns
Reverse Recovery Charge	Qrr		-	10.3	-	μC
Peak Reverse Recovery Current	Ігр		-	38	-	А

Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	Rth(ch-c)	-	-	0.40	°C/W
Channel to Ambient	Rth(ch-a)	-	-	50	°C/W



100

75

°C

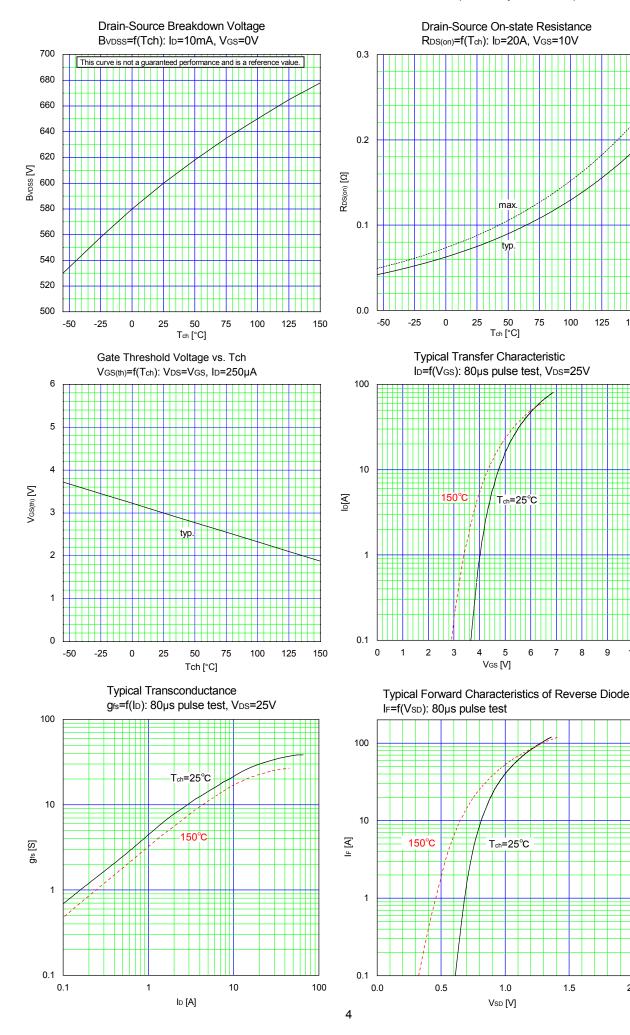
6 7 8 9 10

1.5

2.0

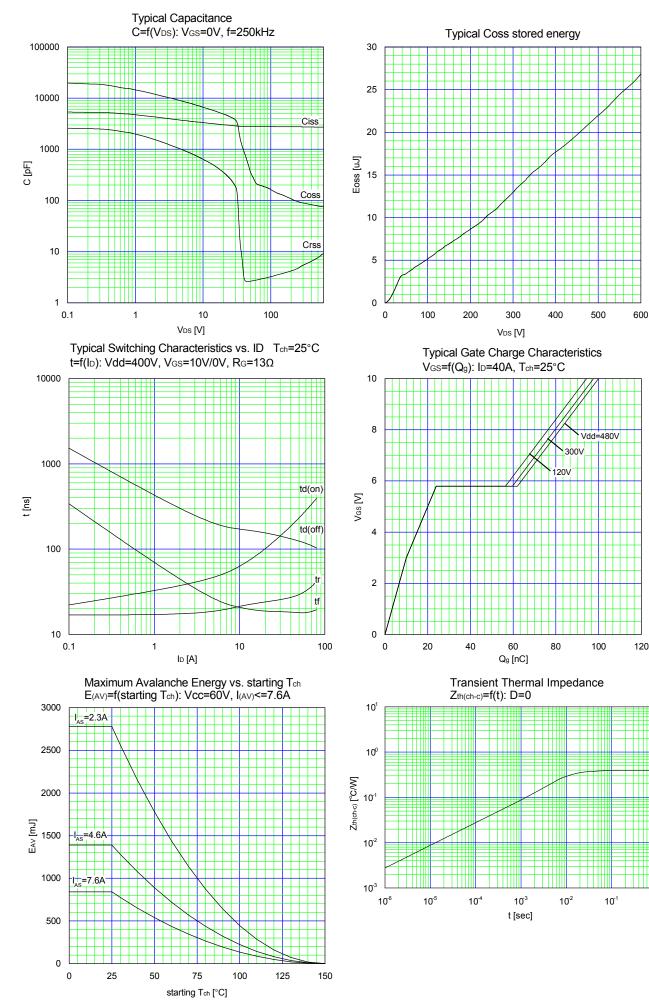
125

150



10⁰

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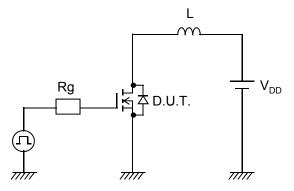


Fig.1 Avalanche Test circuit

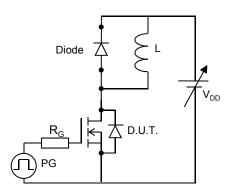


Fig.3 Switching Test circuit

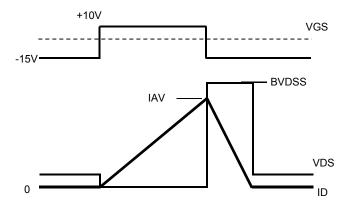


Fig.2 Operating waveforms of Avalanche Test

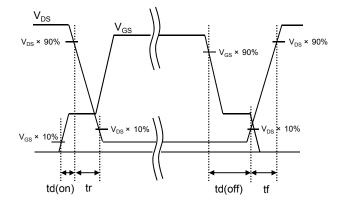


Fig.4 Operating waveform of Switching Test

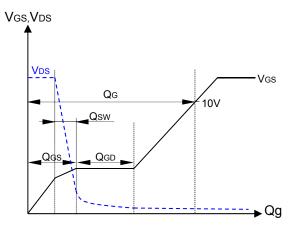
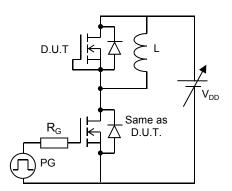


Fig.5 Operating waveform of Gate charge Test



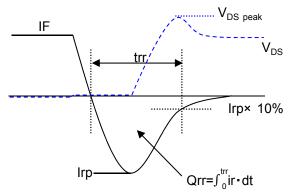
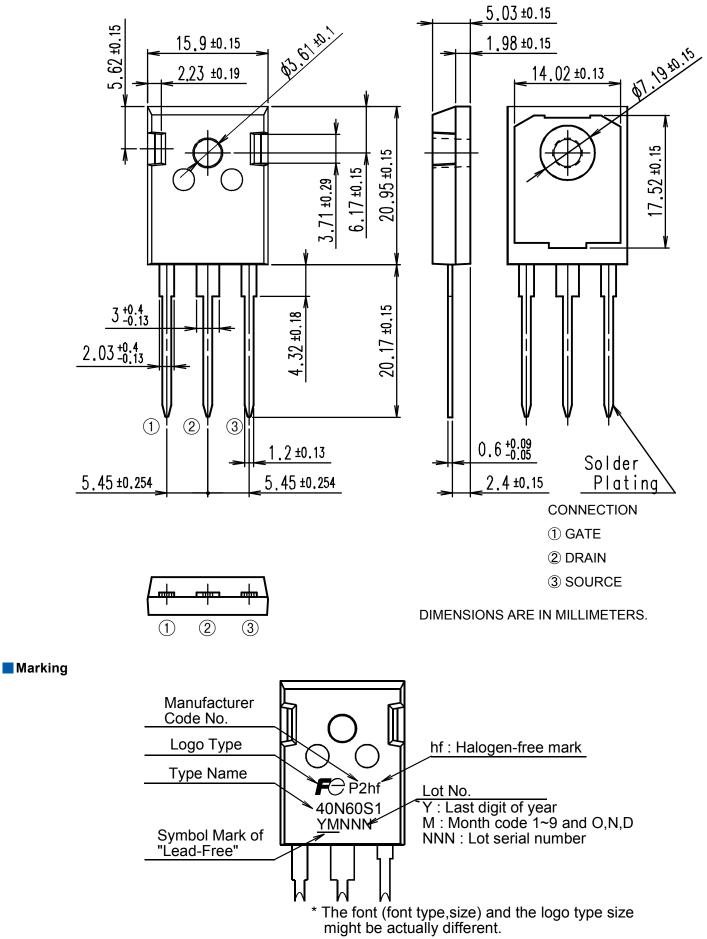


Fig.6 Reverse recovery Test circuit

Fig.7 Operating waveform of Reverse recovery Test

Outview: TO-247 Package



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